

ON Semiconductor®

FDD3670

100V N-Channel PowerTrench[®] MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

These MOSFETs f eature faster switching and lower gate charge than other MOSFETs with comparable $R_{DS(ON)}$ specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

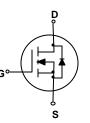
D S **TO-252**

Features

- 34 A, 100 V. $R_{DS(ON)}$ = 32 m Ω @ V_{GS} = 10 V $R_{DS(ON)} = 35 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- Low gate charge (57 nC typical)
- Fast switching speed

High performance trench technology for extremely low R_{DS(ON)}

- High power and current handling capability



Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		100	V
V _{GSS}	Gate-Source Voltage		±20	V
l _D	Drain Current – Continuous	(Note 1)	34	A
	Drain Current – Pulsed	(Note 3)	100	
PD	Maximum Power Dissipation @ T _C = 25°C	(Note 1)	83	W
	@ T _A = 25°C	(Note 1a)	3.8	
	@ T _A = 25°C	(Note 1b)	1.6	
Tj, T _{stg}	Operating and Storage Junction Temperatur	e Range	–55 to +175	°C

Thermal Characteristics

R _{0JC}	Thermal Resistance, Junction-to-Case	(Note 1)	1.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

Package Marking and Ordering Information

FDD3670 FDD3670 13" 16mm 2500 un	Device Marking	Device	Reel Size	Tape width	Quantity
	FDD3670	FDD3670	13"	16mm	2500 units

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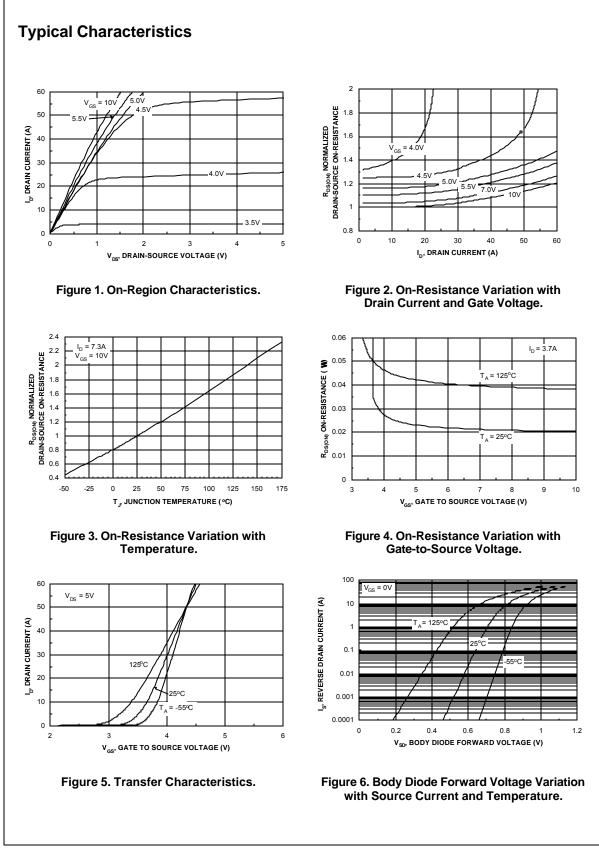
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W _{DSS} Iar Off Char	ource Avalanche Ratings (Note			Тур	Мах	Units
W _{DSS} Iar Off Char	Single Pulse Drain-Source	2)	•	•	•	
Off Char		$V_{DD} = 50 \text{ V}, \qquad I_D = 7.3 \text{ A}$			360	mJ
	Avalanche Energy Maximum Drain-Source Avalanche				7.3	A
	Current				7.5	A
BVpac	acteristics					
USS V USS	Drain–Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	100			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		92		mV/ºC
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$	ł – –		10	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 20 V, V_{DS} = 0 V$	ł – –		100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -20 V$, $V_{DS} = 0 V$	ł – –		-100	nA
	acteristics (Note 2) Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2	2.5	4	V
$\Delta V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $V_{D} = 250 \mu\text{A}$ $V_{D} = 250 \mu\text{A}$, Referenced to 25°C	-	-7.2	-7	w mV/°C
$\Delta V GS(m)$ ΔT_J	Temperature Coefficient					
R _{DS(on)}	Static Drain–Source	$V_{GS} = 10 \text{ V}, I_D = 7.3 \text{ A}$		22	32	mΩ
	On–Resistance	$V_{GS} = 10 \text{ V}, _{D} = 7.3 \text{ A}, _{J} = 125^{\circ}\text{C}$ $V_{GS} = 6 \text{ V}, _{D} = 7.0 \text{ A}$		39 24	56 35	
D(on)	On–State Drain Current	$V_{GS} = 10 V, V_{DS} = 5 V$	25			Α
g _{FS}	Forward Transconductance	$V_{DS} = 5 V$, $I_D = 7.3 A$	15	31		S
-	Characteristics					
Ciss	Input Capacitance	$V_{DS} = 50 V$, $V_{GS} = 0 V$,		2490		pF
- 100	Output Capacitance	f = 1.0 MHz		265		pF
Coss				200		
	Reverse Transfer Capacitance			80		pF
C _{rss}	Reverse Transfer Capacitance					
C _{rss} Switchin	Reverse Transfer Capacitance			80	26	pF
C _{rss} Switchin t _{d(on)}	Reverse Transfer Capacitance g Characteristics (Note 2) Turn-On Delay Time	V _{DD} = 50 V, I _D = 1 A,		80	26	pF ns
C _{rss} Switchin t _{d(on)} t _r	Reverse Transfer Capacitance 19 Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time			80 16 10	18	pF ns ns
C _{rss} Switchin t _{d(on)} t _r	Reverse Transfer Capacitance g Characteristics (Note 2) Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time	V _{DD} = 50 V, I _D = 1 A,		80 16 10 56	18 84	pF ns ns ns
C _{rss} Switchin t _{d(on)} t _r t _{d(off)} t _f	Reverse Transfer Capacitance g Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time	$V_{DD} = 50 \text{ V}, \qquad I_D = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		80 16 10 56 25	18 84 40	pF ns ns ns ns
Crss Switchin td(on) tr td(off) tr Qg	Reverse Transfer Capacitance g Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge	V _{DD} = 50 V, I _D = 1 A,		80 16 10 56	18 84	pF ns ns ns nc
Crss Switchin td(on) tr td(off) tf Qg Qgs	Reverse Transfer Capacitance g Characteristics (Note 2) Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge	$V_{DD} = 50 \text{ V}, \qquad I_D = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 50 \text{ V}, \qquad I_D = 7.3 \text{ A},$		80 16 10 56 25 57	18 84 40	pF ns ns ns ns
Crss Switchin t _{d(on)} tr t _{d(off)} tr Qg Qgs Qgs Qgd	Reverse Transfer Capacitance g Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge Gate–Source Charge Gate–Drain Charge	$V_{DD} = 50 \text{ V}, \qquad I_D = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 50 \text{ V}, \qquad I_D = 7.3 \text{ A},$ $V_{GS} = 10 \text{ V}$		80 16 10 56 25 57 11	18 84 40	pF ns ns ns ns nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd} Drain–Sc	Reverse Transfer Capacitance g Characteristics (Note 2) Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge ource Diode Characteristics	$V_{DD} = 50 \text{ V}, \qquad I_D = 1 \text{ A}, V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 50 \text{ V}, \qquad I_D = 7.3 \text{ A}, V_{GS} = 10 \text{ V}$ and Maximum Ratings		80 16 10 56 25 57 11	18 84 40 80	pF ns ns ns nC nC nC
Crss Switchin t _{d(on)} tr t _{d(off)} tr Qg Qgs Qgs Qgd	Reverse Transfer Capacitance g Characteristics (Note 2) Turn–On Delay Time Turn–On Rise Time Turn–Off Delay Time Turn–Off Fall Time Total Gate Charge Gate–Source Charge Gate–Drain Charge	$V_{DD} = 50 \text{ V}, \qquad I_D = 1 \text{ A}, V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$ $V_{DS} = 50 \text{ V}, \qquad I_D = 7.3 \text{ A}, V_{GS} = 10 \text{ V}$ and Maximum Ratings		80 16 10 56 25 57 11	18 84 40	pF ns ns ns ns nC nC

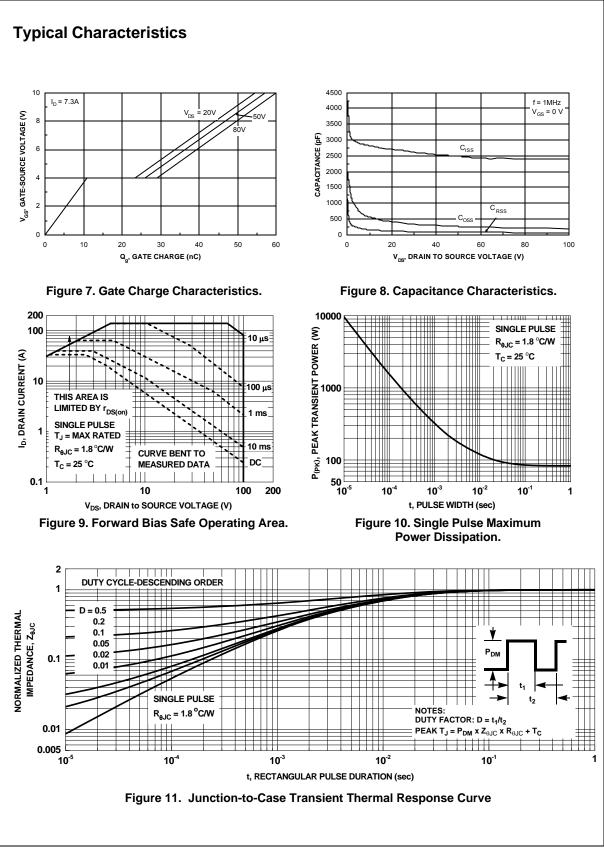
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

3. Pulse Id refers to Figure.9 Forward Bias Safe Operation Area.



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